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(54) **VACUUM STATIC SERVICE BAG FOR SERVERS**

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(71) Applicant: **Dell Products L.P.**, Round Rock, TX (US)

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(72) Inventors: **Eric Michael Tunks**, Austin, TX (US);
Ayedin Nikazm, Austin, TX (US)

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(57) **ABSTRACT**

Embodiments of the present invention provide a method, anti-static bag, and kit for transporting an electronic component in the anti-static bag. Along with the electronic component, a desiccant and a temperature indicator are added to the anti-static bag. The anti-static bag is then vacuum sealed to reduce the air and moisture in the anti-static bag. The vacuum sealed bag, desiccant, and temperature indicator, insure that the formation of condensation on the electronic component will be minimized, which will potentially prolong the life of the electronic component.

